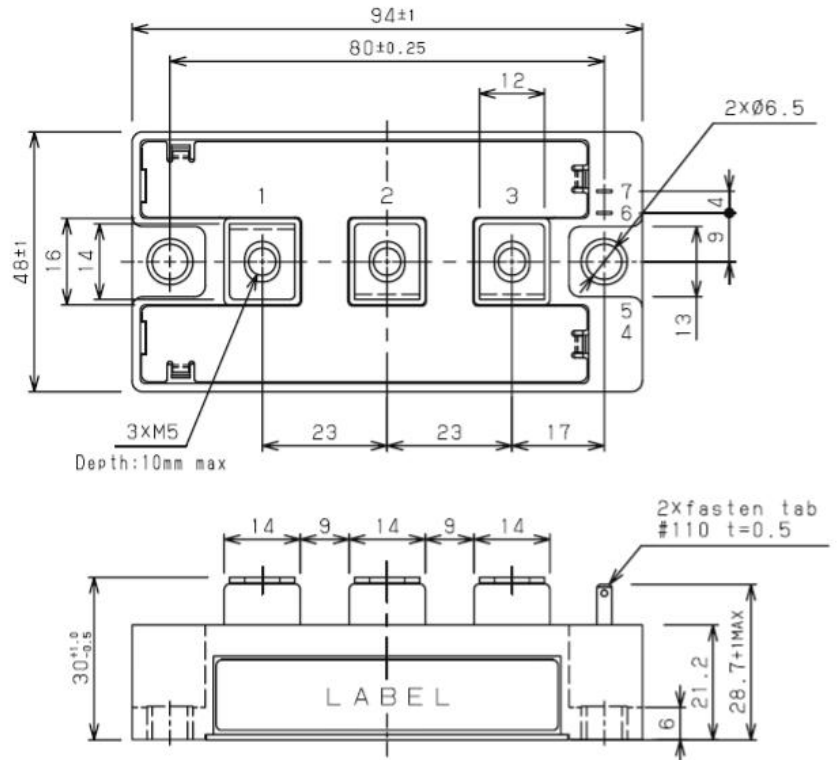
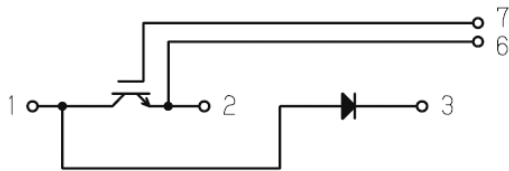


□ 回路図 : *CIRCUIT*

 □ 概略図 : *SCHEMATIC DIAGRAM*

Dimension: [mm]


 □ 最大定格 : *MAXIMUM RATINGS* (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Item		Symbol	Condition	Rated Value	Unit
IGBT	コレクタ・エミッタ間電圧 Collector-Emitter Voltage	V_{CES}	G-E Short	1200	V
	ゲート・エミッタ間電圧 Gate-Emitter Voltage	V_{GES}	C-E Short	± 20	V
	コレクタ電流 Collector Current	I_C	DC $T_c=85^\circ\text{C}$	150	A
		I_{CP}	Pulse $\leq 1\text{ms}$	300	
コレクタ損失 Collector Power Dissipation	P_C	$T_j=175^\circ\text{C}$	789	W	
		$T_j=150^\circ\text{C}$	657		
Diode	繰り返しピーク逆電圧 Repetitive peak reverse voltage	V_{RRM}		1200	V
	順電流 Forward Current	I_F		150	A
		I_{FM}	Pulse $\leq 1\text{ms}$	300	
最大接合温度 Maximum Junction Temperature	T_{jMAX}	瞬時動作(過負荷) Instantaneous Overload	175	$^\circ\text{C}$	
接合温度範囲 Junction Temperature Range	T_j		$-40 \sim +150$	$^\circ\text{C}$	
保存温度範囲 Storage Temperature Range	T_{stg}		$-40 \sim +125$	$^\circ\text{C}$	
絶縁耐圧 Isolation Voltage	V_{ISO}	Terminal to Base AC, 1minute	2,500	V (RMS)	
締め付けトルク Mounting Torque	Module Base to Heatsink	F_{tor}	M6	3	N · m
	Busbar to Main Terminal		M5	2	

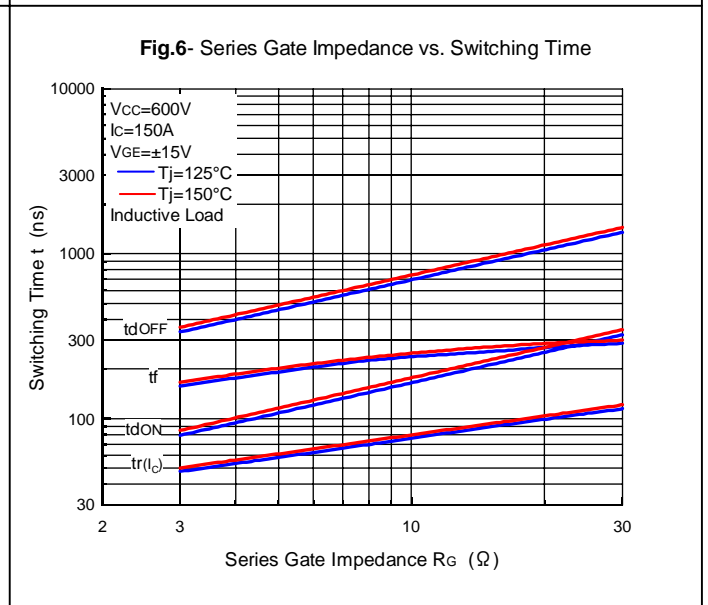
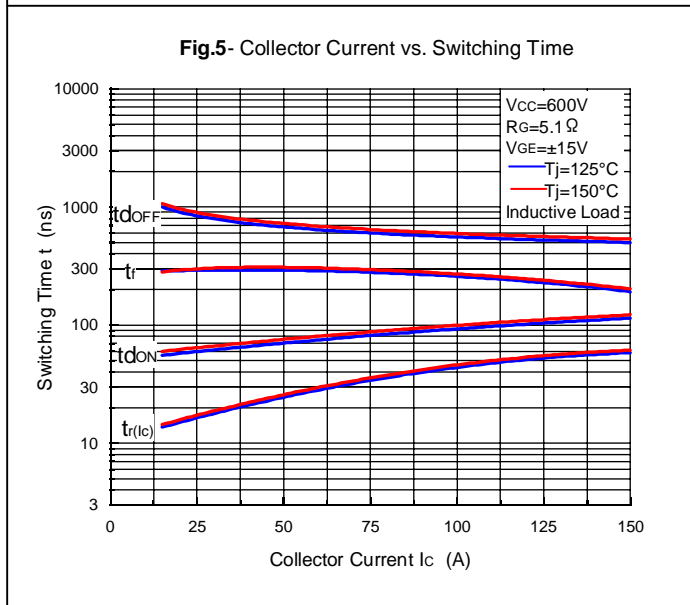
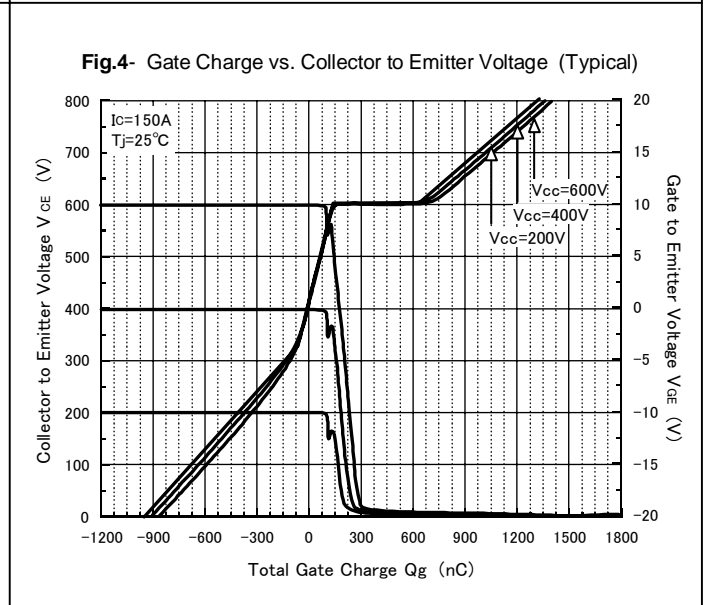
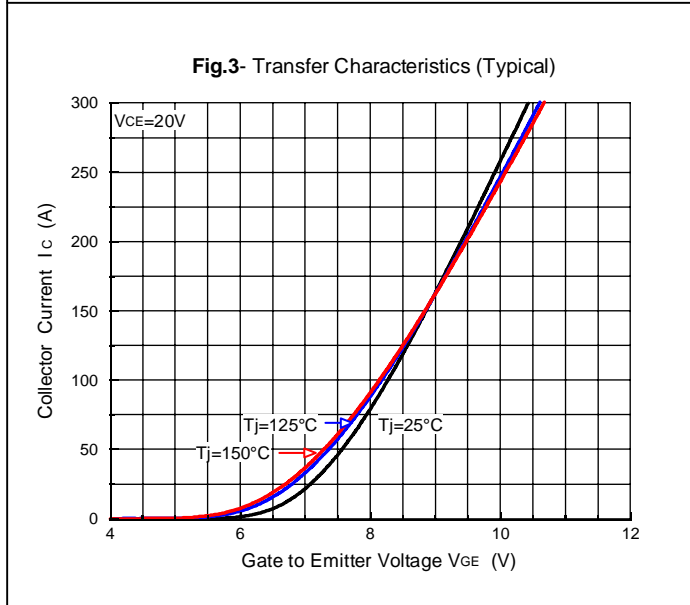
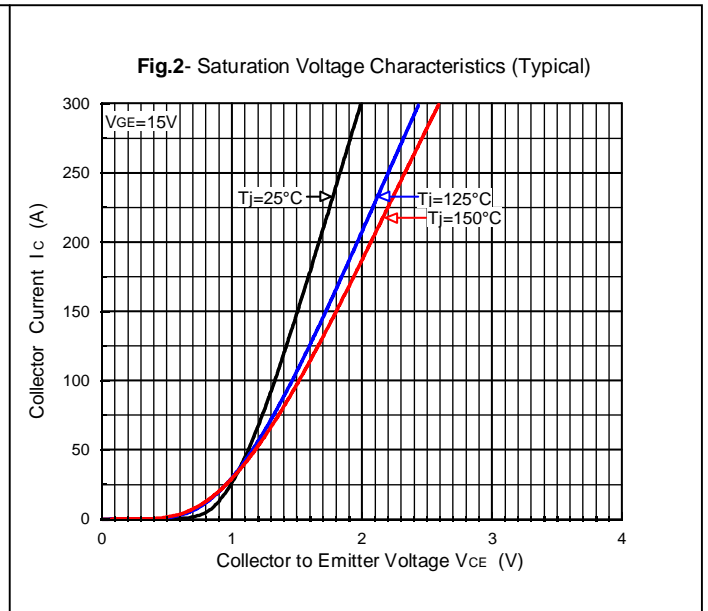
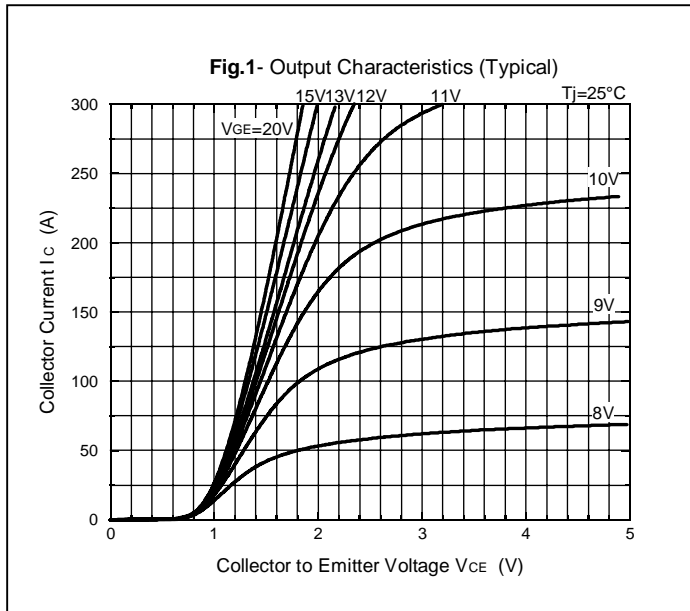
□ 電 氣 的 特 性 : **ELECTRICAL CHARACTERISTICS** (at $T_J=25^\circ\text{C}$ unless otherwise specified)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit	
IGBT	コレクタ遮断電流 Collector-Emitter Cut-Off Current	I_{CES}	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}$	—	—	1.0	mA	
	ゲート漏れ電流 Gate-Emitter Leakage Current	I_{GES}	$V_{GE}=\pm 20\text{V}, V_{CE}=0\text{V}$	—	—	1.0	μA	
	コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage	$V_{CE(sat.)}$	$I_C=150\text{A}, V_{GE}=15\text{V}$ (chip level)	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ $T_J=150^\circ\text{C}$	— — —	1.50 1.70 1.80	2.00 — —	V
	ゲートしきい値電圧 Gate-Emitter Threshold Voltage	$V_{GE(th.)}$	$V_{CE}=10\text{V}, I_C=5.0\text{mA}$		4.8	—	7.0	V
	入力容量 Input Capacitance	C_{ies}	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		—	15.0	—	nF
	出力容量 Output Capacitance	C_{oes}			—	0.43	—	
	帰還容量 Reverse Transfer Capacitance	C_{res}			—	0.35	—	
	ゲート電荷量 Gate Charge	Q_g	$V_{CC}=600\text{V}, I_C=150\text{A}, V_{GE}=-15\sim+15\text{V}$		—	1650	—	nC
	スイッチング時間 Switching Time	上昇時間 Rise Time	t_r	$V_{CC}=600\text{V}, L_s=38\text{nH}$ $I_C=150\text{A}$ Inductive Load $R_G=5.1\Omega$ $V_{GE}=\pm 15\text{V}$ $T_J=150^\circ\text{C}$	—	60	—	ns
		ターンオン遅延時間 Turn-on Delay Time	$t_d(on)$		—	110	—	
下降時間 Fall Time		t_f	—		200	—		
ターンオフ遅延時間 Turn-off Delay Time		$t_d(off)$	—		500	—		
Diode	順電圧 Peak Forward Voltage	V_F	$I_F=150\text{A}, V_{GE}=0\text{V}$ (chip level)	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$ $T_J=150^\circ\text{C}$	— — —	2.00 1.98 1.95	2.60 — —	V
	逆回復時間 Reverse Recovery Time	t_{rr}	$V_{CC}=600\text{V}, L_s=38\text{nH}$ $I_C=150\text{A}$ Inductive Load $R_G=5.1\Omega$ $V_{GE}=\pm 15\text{V}$ $T_J=150^\circ\text{C}$		—	190	—	ns
内部配線抵抗 Internal Lead Resistance		R_{CC+EE}	主端子—チップ間 / 1素子 Main Terminal - Chip / Per 1 Arm		—	—	1	m Ω
内部インダクタンス Stray Inductance		L_{SCE}	メイン端子3—2間 Main Terminal 3 - Main Terminal 2		—	30	—	nH

 □ 熱 的 特 性 : **THERMAL CHARACTERISTICS**

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱 抵 抗 Thermal Resistance	IGBT	$R_{th(j-c)}$	Junction to Case Per 1 Arm (T _c 測定点:チップ直下)	—	—	0.19	°C/W
	Diode			—	—	0.30	
接 触 熱 抵 抗 Thermal Resistance	IGBT	$R_{th(c-f)}$	Case to heatsink Per 1 Arm Paste=1W/(m ² °C)	—	0.05	—	
	Diode			—	0.10	—	

特性图 : CHARACTERISTICS CURVES



特性 : CHARACTERISTICS CURVES

